

THROUGH-HOLE MICRO SOCKET

(1.27 mm) .050" PITCH • SLM/SMS SERIES



SLM

Mates:

HTMS, TMS, MTMS, DWM, HDWM, FTR, HMTMS

SMS

Mates:

HTMS, TMS, MTMS, DWM, HDWM, FTR, TML, ZML, HMTM

SPECIFICATIONS

Insulator Material:

SLM: Black Glass Filled Polyester SMS: Black LCP

Contact Material:

Phosphor Bronze Plating: Au or Sn over 50 μ" (1.27 μm) Ni Current Rating (SLM/TMS): 5 2 Δ per pin

5.2 A per pin (2 pins powered) Current Rating (SMS/TMS):

5.0 A per pin

5.0 A per pin (2 pins powered) Operating Temp Range: -55 °C to +125 °C with Gold -55 °C to +105 °C with Tin

Insertion Depth:

INSERTION Depth: SLM: (2.03 mm) .080" to (3.05 mm) .120" SMS: (3.43 mm) .135" to (6.35 mm) .250" with (0.38 mm) .015" wipe

PROCESSING

Lead-Free Solderable:

SLM: No, Lead Wave Only SMS: Yes

ALSO AVAILABLE

Other Platings (MOQ Required)







(1.27) .050 X No. of Positions

01 thru 50



(2.54)

PLATING OPTION

= $10 \,\mu$ " (0.25 μ m) Gold on contact, Matte Tin on tail

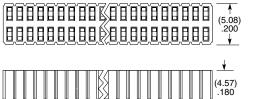
-G = 20 μ " (0.51 μ m) Gold on contact, Gold flash on balance

ROW OPTION

-S Single









SMS



01 thru 50

NO. PINS PER ROW

LEAD STYLE

Specify LEAD **STYLE** from

chart

PLATING OPTION

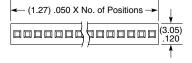
= 10 μ " (0.25 μ m) Gold on contact, Matte Tin on tail

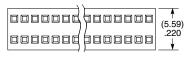
= 20 μ" (0.51 μm) Gold on contact, Gold flash on balance

ROW OPTION



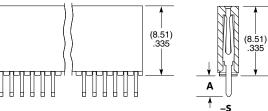
-D = Double Row





LEAD STYLE	A
-01	(2.54) .100
-02	(4.83) .190

-D



Note:

Some lengths, styles and options are non-standard, non-returnable.